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APPLICANT:	APPLICANT: YANG ET AL			
FILING DATE: DECEM	IBER 8 2003	GROUP: 1712		
. PATENT DOCUMEN	TS			
TE NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
89 Buysch et al.	524	504		
Kress et al.	524	141		
2 Lim et al.	524	97		
3 Lim et al.	252	609		
3 Lim et al.	524	100		
4 Yang et al.				
3 Yang et al.	_			
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	APPLICANT: FILING DATE: DECEM B. PATENT DOCUMEN NAME Buysch et al. Kress et al. Lim et al. Lim et al. Yang et al. Yang et al.	### DKC 1720.01 APPLICANT: YANG FILING DATE: DECEMBER 8 2003 B. PATENT DOCUMENTS FE NAME CLASS Buysch et al. 524 Kress et al. 524 Lim et al. 524 Lim et al. 524 Yang et al. 524 Yang et al. 524	DKC 1720.01 10	

FOREIGN PATENT DOCUMENTS							
EXAMINER DOCUMENT NUMBER INITIALS	DOCTIMENT NITURED	DATE	COUNTRY	CLASS	SI TOOL A GO	TRANSLATION	
	DATE COUNTRY	CLASS	SUBCLASS	YES	NO		
DR	1994-0014647	7/19/94	Korea				х
	8-208884	8/13/96	Japan				х
	-7-76649	3/2/95	Japan				х
V	EP 0 728 811 A2	8/28/96	Europe			X	

EXAMINER INITIALS	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)		
03	Abstract of Korean Patent Application Laid-open No. 94-14647, July 19, 1994 Abstract of Japanese Patent Laid-open No. 8-208884, August 13, 1996 Abstract of Japanese Patent Laid-open No. 7-76649, March 2, 1995 Abstract of EP0936244, August 18, 1999		
EXAMINER: Ini	David Buttle tial if citation considered, whether or not citation not considered. Include copy of this form with	DATE CONSIDERED 5/16/05 is in conformance with MPEP 609; draw line through citation if not in next communication to applicant.	